

## **BCX17**

## **PNP General Purpose Amplifier**

- This device is esigned for general purpose amplifier and switching application at current 0.5A.
- Sourced from process 78.



1. Base 2. Emitter 3. Collector

### **Absolute Maximum Ratings** T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	d	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage		45	V
V <sub>CBO</sub>	Collector-Base Voltage	71. 50	50	V
V <sub>EBO</sub>	Emitter-Base Voltage	23	5.0	V
I <sub>C</sub>	Collector current - Continuo	us	500	mA
T <sub>J</sub> , T <sub>stg</sub>	Junction and Storage Temperature		-55 ~ +150	°C

# Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	eristics					
V <sub>(BR)CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 10mA, I <sub>B</sub> = 0	45			V
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	$I_{\rm C} = 10\mu{\rm A},\ I_{\rm C} = 0$	50			V
I <sub>CBO</sub>	Collector Cutoff Current	$V_{CE} = 20V, I_{E} = 0$			100	nA
		$V_{CE} = 20V, I_{E} = 0, TA = 150^{\circ}C$			5.0	μΑ
I <sub>EBO</sub>	Emitter Cutoff Current	$V_{EB} = 5.0 V, I_{C} = 0$			10	μΑ
On Characteristics						
h <sub>FE</sub>	DC Current Gain	$I_C = 100 \text{mA}, V_{CE} = 1.0 \text{V}$	100		600	
		$I_C = 300 \text{mA}, V_{CE} = 1.0 \text{V}$	70			
		$I_C = 500 \text{mA}, V_{CE} = 1.0 \text{V}$	40			
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA			0.62	V
V <sub>BE(on)</sub>	Base-Emitter On Voltage	I <sub>C</sub> = 500mA, V <sub>CE</sub> = 1.0V			1.2	V

# Thermal Characteristics $\rm T_A=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	300	mW
	Alumina Substrate,** T <sub>A</sub> = 25°C		
	Derate above 25°C	2.4	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	417	°C/W

<sup>\*\*</sup> Alumina = 0.4×0.3×0.024 in. 9.5% alumina

# **Package Dimensions** SOT-23 0.20 MIN 0.45~0.60 $0.4\underline{0} \pm 0.03$ 1.30 ±0.10 0.03~0.10 0.38 REF $0.12^{\,+0.05}_{\,-0.023}$ 0.40 ±0.03 0.96~1.14 2.90 ±0.10 0.97REF 0.95 ±0.03 0.95 ±0.03 1.90 ±0.03 0.508REF Dimensions in Millimeters

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EnSigna™	$I^2C^{TM}$	$OCX^{TM}$	RapidConfigure™	UHC™
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